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Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICATION (Use as many sheets as necessary) Sheet 1 of 5

Application Number	10/081818
Filing Date	February 20, 2002
First Named Inventor	Eldridge, Jerome
Group Art Unit	2818
Examiner Name	Ho, Tu-Tu

Attorney Docket No: 1303.04	15051
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